CD54HCT258, CD74HCT258 QUADRUPLE 2-LINE TO 1-LINE SELECTORS/MULTIPLEXERS WITH 3-STATE OUTPUTS

SCHS276A - MAY 2003

- 4.5-V to 5.5-V V_{CC} Operation
- Wide Operating Temperature Range of -55°C to 125°C
- Balanced Propagation Delays and Transition Times
- Standard Outputs Drive Up To 10 LS-TTL Loads
- Significant Power Reduction Compared to LS-TTL Logic ICs
- Inputs Are TTL-Voltage Compatible

CD54HCT258...F PACKAGE CD74HCT258...E PACKAGE (TOP VIEW) 16 VCC Ā/B G 1A 15 ∏ 1B 14**∏** 4A 1Y 13 AB 2A 12**∏** 4Y 2B П6 11 T 3A 2Y 10 3B GND 9 🛮 3Y

description/ordering information

These devices are designed to multiplex signals from 4-bit data sources to 4-output data lines in bus-organized systems. The 3-state outputs do not load the data lines when the output-enable (\overline{G}) input is at a high logic level.

To ensure the high-impedance state during power up or power down, \overline{G} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

ORDERING INFORMATION

TA	PAC	KAGE†	ORDERABLE PART NUMBER	TOP-SIDE MARKING
–55°C to 125°C	PDIP – E	Tube	CD74HCT258E	CD74HCT258E
-55 C to 125 C	CDIP – F	Tube	CD54HCT258F3A	CD54HCT258F3A

[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

FUNCTION TABLE

	INPU	OUTPUT		
G	Ā/B	Α	В	Y
Н	Х	Χ	Х	Z
L	L	L	Χ	Н
L	L	Н	Χ	L
L	Н	Χ	L	Н
L	Н	Χ	Н	L

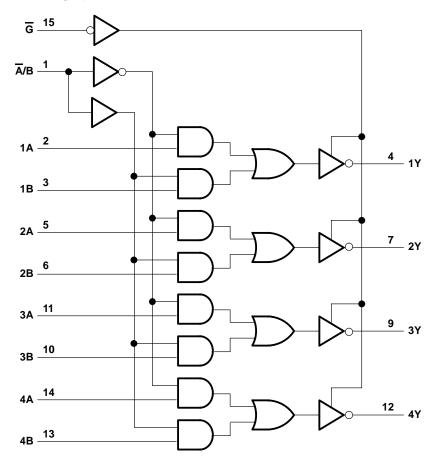


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logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V _{CC}	0.5 V to 7 V
Input clamp current, $I_{ K }(V_1 < 0 \text{ or } V_1 > V_{CC})$ (see Note 1)	±20 mA
Output clamp current, I_{OK} ($V_O < 0$ or $V_O > V_{CC}$) (see Note 1)	±20 mA
Continuous output drain current per output, $I_O(V_O = 0 \text{ to } V_{CC})$	±35 mA
Continuous output source or sink current per output, I_O ($V_O = 0$ to V_{CC})	±25 mA
Continuous current through V _{CC} or GND	±50 mA
Package thermal impedance, θ _{JA} (see Note 2): E package	69°C/W
Storage temperature range, T _{stq}	–65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

2. The package thermal impedance is calculated in accordance with JESD 51-7.



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recommended operating conditions (see Note 3)

		MIN	MAX	UNIT
Vcc	Supply voltage	4.5	5.5	V
VIH	High-level input voltage	2		V
VIL	Low-level input voltage		0.8	V
VI	Input voltage		VCC	V
Vo	Output voltage		VCC	V
Δt/Δν	Input transition rise or fall rate		500	ns
TA	Operating free-air temperature	-55	125	°C

NOTE 3: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST	CONDITIONS	VCC	V _{CC} T _A = 2		T _A = -55°C TO 125°C		T _A = -40°C TO 85°C		UNIT
				MIN MAX			MAX	MIN	MAX	
\/o	\\ \\ or \\.	I _{OH} = -20 μA	4.5 V	4.4		4.4		4.4		V
VOH	AI = AIH OL AIL	VI = VIH or VIL IOH = -6 mA		3.98		3.7		3.84		V
Voi	//. = \/ or \/	I _{OL} = 20 μA			0.1		0.1		0.1	V
VOL	$V_I = V_{IH}$ or V_{IL}	$I_{OL} = 6 \text{ mA}$	4.5 V		0.26		0.4		0.33	V
lį	VI = ACC or 0	5.5 V		±0.1		±1		±1	μΑ	
loz	$V_O = V_{CC}$ or 0		5.5 V		±0.5		±10		±5	μΑ
ICC	$V_I = V_{CC}$ or 0,	IO = 0	5.5 V		8		160		80	μΑ
∆l _{CC} †	One input at V _{CC} – 2	2.1 V, Other inputs at 0 or V _{CC}	4.5 V to 5.5 V	100	360		490		450	μΑ
C _i					10		10		10	pF
Co					20		20		20	pF

 $[\]bar{T}$ Additional quiescent supply current per input pin, TTL inputs high, 1 unit load. For dual-supply systems, theoretical worst-case (V_I = 2.4 V, V_{CC} = 5.5 V) specification is 1.8 mA.

HCT INPUT LOADING TABLE

INPUT	UNIT LOAD					
G	1.5					
A or B	0.5					
Ā/B	1.5					

Unit Load is ΔI_{CC} limit specified in electrical characteristics table (e.g., 360 μA max at 25°C).



CD54HCT258, CD74HCT258 QUADRUPLE 2-LINE TO 1-LINE SELECTORS/MULTIPLEXERS **WITH 3-STATE OUTPUTS**

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switching characteristics over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	LOAD CAPACITANCE	Vcc	T,	T _A = 25°C				T _A = -		T _A = -		UNIT						
	(INFO1)	(001F01)	CAFACITANCE		MIN TYP MAX	MIN	MAX	MIN	MAX											
	A or B	Any Y	C _L = 50 pF	4.5 V			27		41		34									
	AUID	Ally i	C _L = 15 pF	5 V		11						ns								
^t pd	Ā/B	Any Y	C _L = 50 pF	4.5 V			34		51		43	115								
A/B	A/B	Ally 1	Ally 1	Ally I	Ally I	Ally I	Ally I	Ally I	Ally I	Ally I	C _L = 15 pF	5 V		14						
	G	Any Y	C _L = 50 pF	4.5 V			28		42		35	20								
t _{en}	5	Ally i	C _L = 15 pF	5 V		11						ns								
4	G	Any Y	C _L = 50 pF	4.5 V			30		45		38	20								
^t dis	G	Ally I	C _L = 15 pF	5 V		12			·			ns								
t _t		Any Y	C _L = 50 pF				12		18		15	ns								

operating characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$

PARAMETER	TYP	UNIT
C _{pd} Power dissipation capacitance per multiplexer [†]	49	pF

† C_{pd} is used to determine the dynamic power consumption per multiplexer.

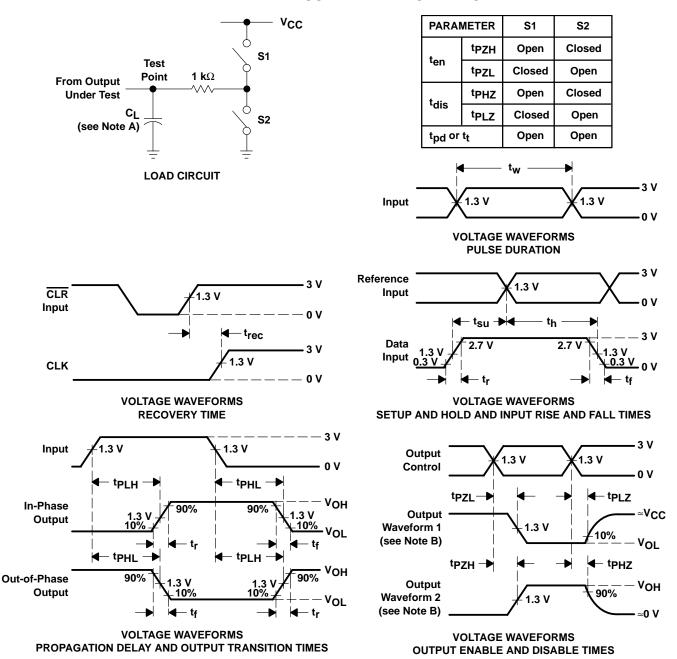
 $P_D = V_{CC}^2 fi (C_{pd} + C_L)$ where: $P_D =$ dynamic power dissipation

fi = input frequency

C_L = output load capacitance V_{CC} = supply voltage

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PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_L includes probe and test-fixture capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. Phase relationships between waveforms were chosen arbitrarily. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, Z_O = 50 Ω , t_f = 6 ns.
- D. For clock inputs, f_{max} is measured with the input duty cycle at 50%.
- E. The outputs are measured one at a time with one input transition per measurement.
- F. tpLz and tpHz are the same as tdis.
- G. t_{PZL} and t_{PZH} are the same as t_{en} .
- H. tplH and tpHL are the same as tpd.

Figure 1. Load Circuit and Voltage Waveforms





PACKAGE OPTION ADDENDUM

28-Feb-2005

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins I	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
5962-8970801EA	ACTIVE	CDIP	J	16	1	None	Call TI	Level-NC-NC-NC
CD54HCT258F3A	ACTIVE	CDIP	J	16	1	None	Call TI	Level-NC-NC-NC
CD74HCT258E	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - May not be currently available - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

None: Not yet available Lead (Pb-Free).

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

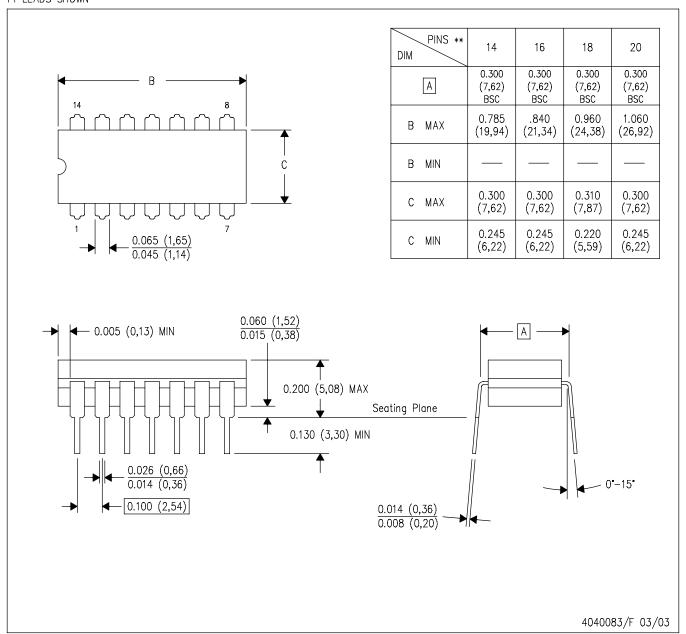
Green (RoHS & no Sb/Br): TI defines "Green" to mean "Pb-Free" and in addition, uses package materials that do not contain halogens, including bromine (Br) or antimony (Sb) above 0.1% of total product weight.

(3) MSL. Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDECindustry standard classifications, and peak solder temperature.

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14 LEADS SHOWN



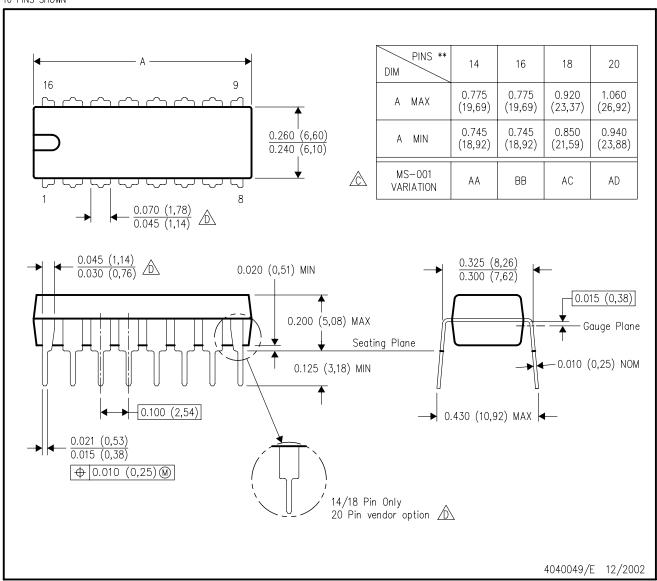
NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



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